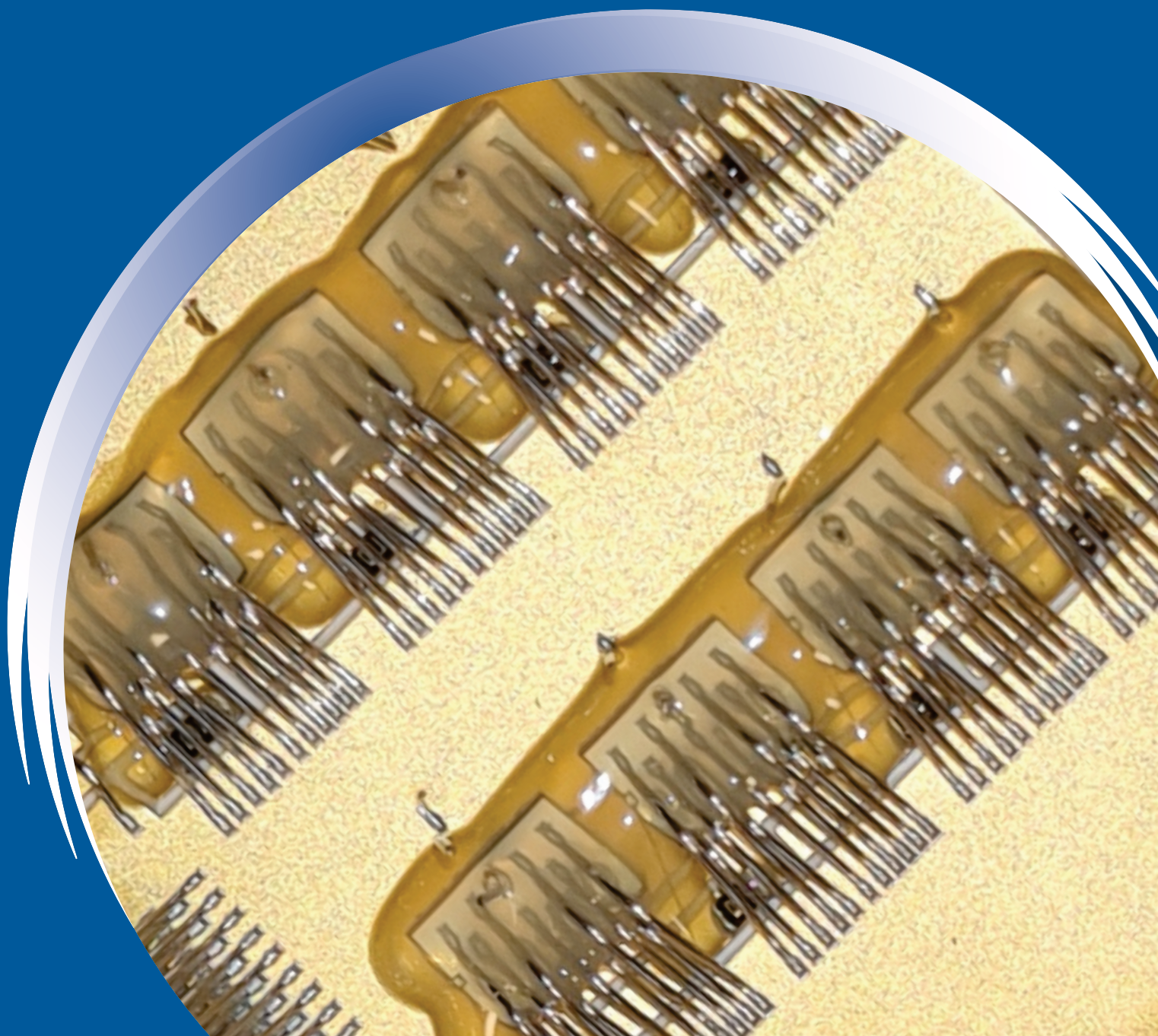


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# MIDEM 2022

## 57<sup>th</sup> INTERNATIONAL CONFERENCE ON MICROELECTRONICS, DEVICES AND MATERIALS WITH THE WORKSHOP ON ENERGY HARVESTING: MATERIALS AND APPLICATIONS

September 14<sup>th</sup> – September 16<sup>th</sup>, 2022  
 Slovenia

### Announcement and Call for Papers

#### Chairs:

**Prof. Dr. Tadej Rojac**  
**Assist. Prof. Dr. Mojca Otoničar**

#### IMPORTANT DATES

##### **Abstract submission deadline:**

May 1, 2022

##### **Acceptance notification:**

June 15, 2022

##### **Full paper submission deadline:**

July 31, 2022

Invited and accepted papers will be published in the Conference Proceedings.

Detailed and updated information about the MIDEM Conferences, as well as for paper preparation can be found on

<http://www.midem-drustvo.si//>

#### GENERAL INFORMATION

The 57<sup>th</sup> International Conference on Microelectronics, Devices and Materials with the Workshop on Energy harvesting: materials and applications continues a successful tradition of the annual international conferences organised by the MIDEM Society, the Society for Microelectronics, Electronic Components and Materials. The conference will be held from **SEPTEMBER 14<sup>th</sup> – 16<sup>th</sup>, 2022**.

#### Topics of interest include but are not limited to:

- Energy harvesting: modelling, materials, devices,
- Novel monolithic and hybrid circuit processing techniques,
- New device and circuit design,
- Process and device modelling,
- Semiconductor physics,
- Sensors and actuators,
- Electromechanical devices, microsystems and nanosystems,
- Nanoelectronics,
- Optoelectronics,
- Photovoltaic devices,
- Electronic materials science and technology,
- New electronic materials and applications,
- Materials characterization techniques,
- Reliability and failure analysis,
- Education in microelectronics, devices and materials.

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MIDEM Society - Society for Microelectronics, Electronic Components and Materials, Slovenia

#### CO-ORGANIZER:

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 European Union, European Regional Development fund

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